



Power MOSFETS

DATASHEET

LM60185DAQ8A

Dual N-Channel
Enhancement Mode MOSFET

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Quality Management Systems

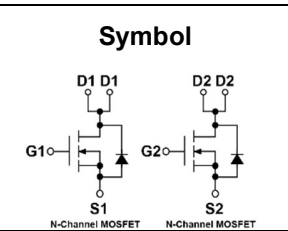
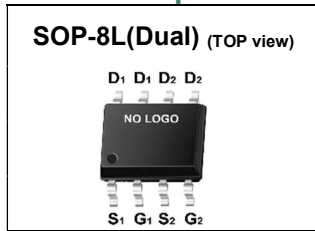
ISO 9001:2015 Certificate

LM60185DAQ8A



Dual N-Channel Enhancement Mode MOSFET

Pin Description



Product Summary

Symbol	Dual N-Channel	Unit
V_{DSS}	60	V
$R_{DS(ON)-Max}$	18.5	m Ω
I_D	8.4	A

Feature

- Fast switching speed
- Reliable and Rugged
- ROHS Compliant & Halogen-Free
- 100% UIS and Rg Tested

Applications

- Fan Motor Control
- Synchronous Rectification

Ordering Information

Orderable Part Number	Package Type	Form	Shipping	Marking
LM60185DAQ8A	SOP-8L(Dual)	Tape & Reel	3000 / Tape & Reel	60185 □□□□□□

Note : □□□□□□ = Lot Code

Absolute Maximum Ratings (T_J=25°C Unless Otherwise Noted)

Symbol	Parameter	Dual N-Channel	Unit
V_{DSS}	Drain-Source Voltage	60	V
V_{GSS}	Gate-Source Voltage	±20	
T_J	Maximum Junction Temperature	150	°C
T_{STG}	Storage Temperature Range	-55 to 150	°C
I_S	Diode Continuous Forward Current	$T_A=25^\circ\text{C}$ 1.2	A
$I_{DM}^{(1)}$	Pulse Drain Current Tested	$T_A=25^\circ\text{C}$ 21	A
I_D	Continuous Drain Current	$T_A=25^\circ\text{C}$ 8.4	A
		$T_A=70^\circ\text{C}$ 6.7	
P_D	Maximum Power Dissipation	$T_A=25^\circ\text{C}$ 1.3	W
		$T_A=70^\circ\text{C}$ 0.8	
$I_{AS}^{(2)}$	Avalanche Current, Single pulse	L=0.1mH 23	A
		L=0.5mH 12	
$E_{AS}^{(2)}$	Avalanche Energy, Single pulse	L=0.1mH 26.5	mJ
		L=0.5mH 36	

Thermal Characteristics

Symbol	Parameter	Rating	Unit
$R_{\theta JA}^{(3)}$	Thermal Resistance-Junction to Ambient	$t \leq 10s$	54
		Steady State	95

Note ① : Max. current is limited by junction temperature

Note ② : UIS tested and pulse width are limited by maximum junction temperature 150°C

Note ③ : Surface Mounted on 1in² FR-4 board with 1oz.

LM60185DAQ8A



Dual N-Channel Electrical Characteristics (T_J=25°C Unless Otherwise Noted)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Static Electrical Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _{DS} =250uA	60	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	V _{DS} =48V, V _{GS} =0V	-	-	1	uA
V_{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _{DS} =250uA	1	1.8	2.5	V
I_{GSS}	Gate Leakage Current	V _{GS} =±20V, V _{DS} =0V	-	-	±100	nA
R_{DS(ON)} ^④	Drain-Source On-state Resistance	V _{GS} =10V, I _{DS} =6A	-	14	18.5	mΩ
		V _{GS} =4.5V, I _{DS} =5A	-	16	21	
g_{fs}	Forward Transconductance	V _{DS} =5V, I _{DS} =6A	-	16	-	S
Dynamic Characteristics ^⑤						
R_G	Gate Resistance	V _{GS} =0V, V _{DS} =0V, Freq.=1MHz	-	1	-	Ω
C_{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =30V, Freq.=1MHz	-	2172	-	pF
C_{oss}	Output Capacitance		-	112	-	
C_{rss}	Reverse Transfer Capacitance		-	87	-	
t_{d(ON)}	Turn-on Delay Time	V _{GS} =10V, V _{DS} =30V, I _D =1A, R _{GEN} =6Ω	-	9.2	-	nS
t_r	Turn-on Rise Time		-	17.5	-	
t_{d(OFF)}	Turn-off Delay Time		-	40.1	-	
t_f	Turn-off Fall Time		-	30.3	-	
Q_g	Total Gate Charge	V _{GS} =4.5V, V _{DS} =30V, I _D =6A	-	24.5	-	nC
Q_g	Total Gate Charge	V _{GS} =10V, V _{DS} =30V, I _D =6A	-	52	-	
Q_{gs}	Gate-Source Charge		-	10	-	
Q_{gd}	Gate-Drain Charge		-	7.6	-	
Source-Drain Characteristics						
V_{SD} ^④	Diode Forward Voltage	I _{SD} =1A, V _{GS} =0V	-	0.7	1.1	V
t_{rr}	Reverse Recovery Time	I _F =1A, V _R =0V	-	18	-	nS
Q_{rr}	Reverse Recovery Charge	dI _F /dt=100A/μs	-	11	-	nC

Note ④ : Pulse test (pulse width≤300us, duty cycle≤2%).

Note ⑤ : Guaranteed by design, not subject to production testing.

Dual N-Channel Typical Characteristics

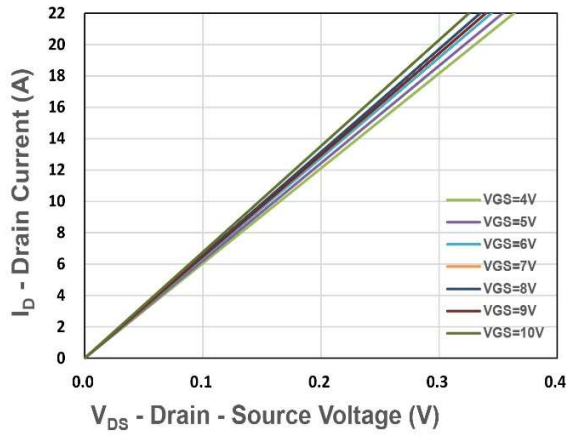


Figure 1. Output Characteristics

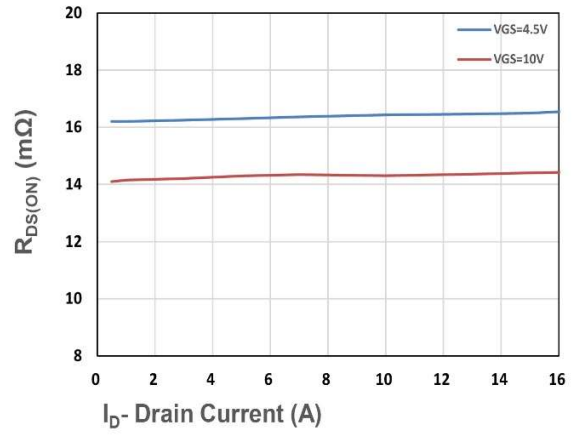


Figure 2. On-Resistance vs. ID

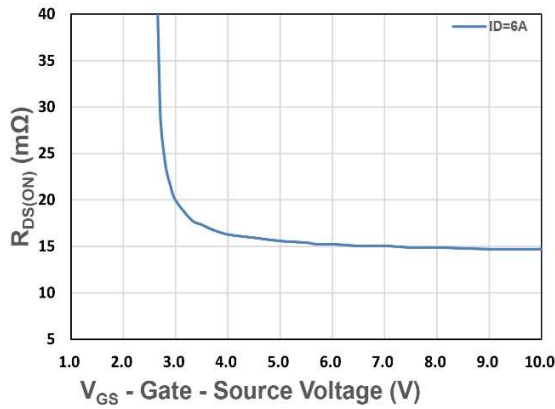


Figure 3. On-Resistance vs. VGS

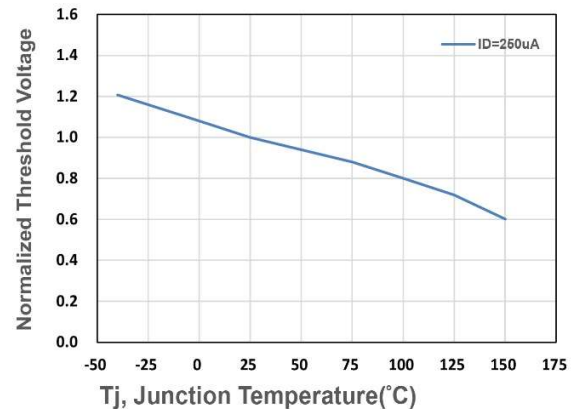


Figure 4. Gate Threshold Voltage

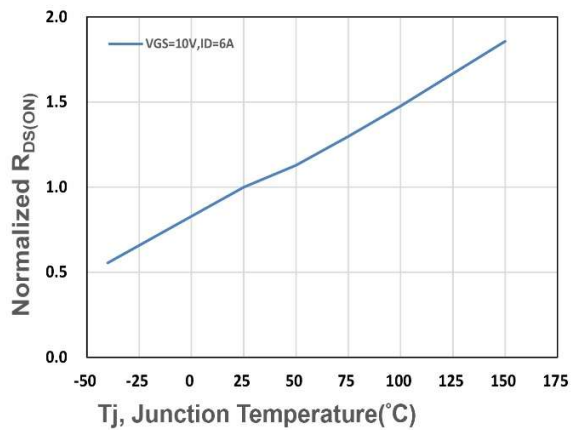


Figure 5. Drain-Source On Resistance

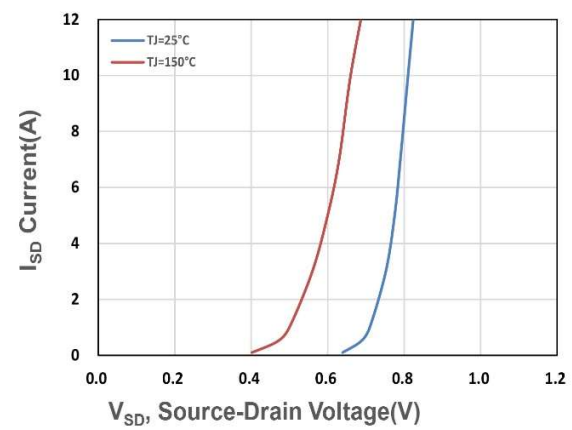


Figure 6. Source-Drain Diode Forward

LM60185DAQ8A

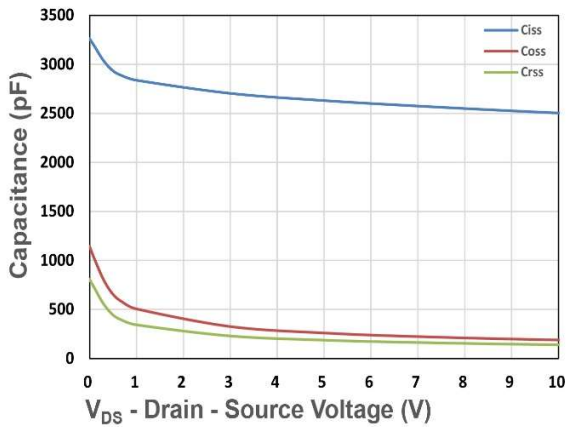


Figure 7. Capacitance

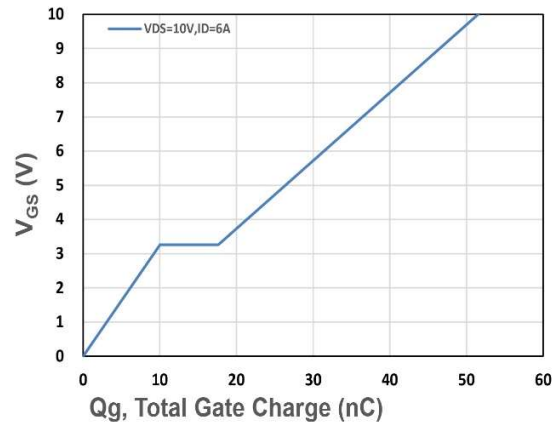


Figure 8. Gate Charge Characteristics

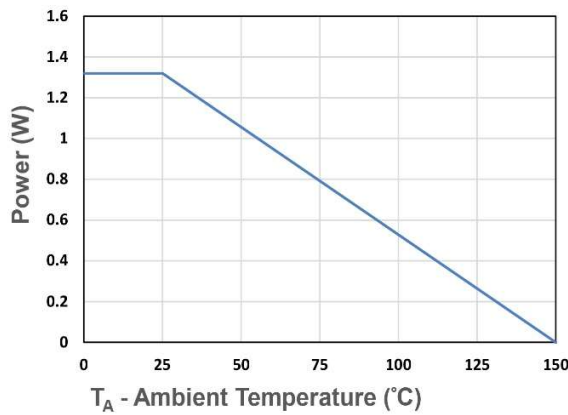


Figure 9. Power Dissipation

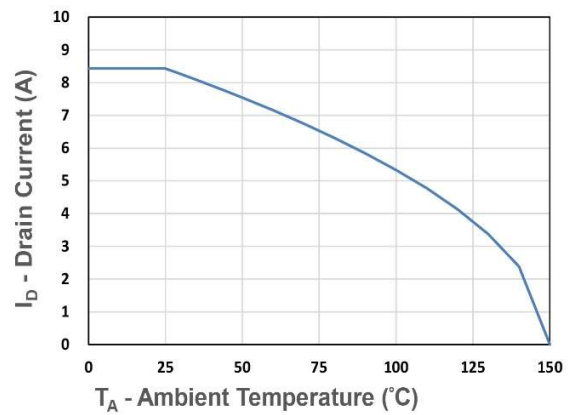


Figure 10. Drain Current

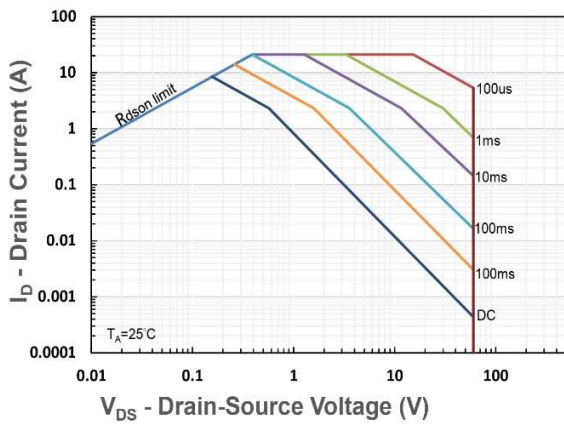


Figure 11. Safe Operating Area

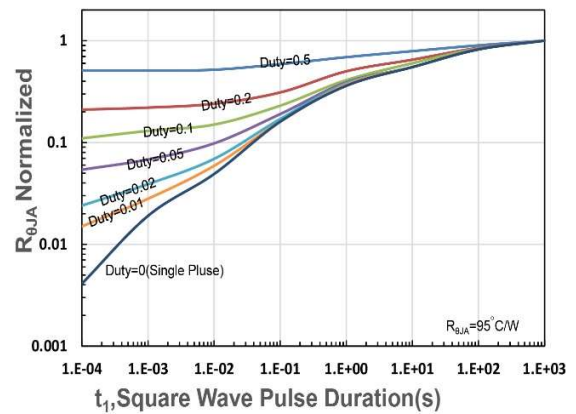


Figure 12. $R_{\theta JA}$ Transient Thermal Impedance